

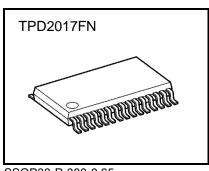
Toshiba Intelligent Power Device Silicon Monolithic MOS Integrated Circuit

# **TPD2017FN**

Low side switch (8-channels) for motors, solenoids, lamp drives

#### 1. Description

TPD2017FN is a low-side switch (8 channels) with MOS FET out. This is the monolithic power IC that can be driven directly from CMOS, TTL logic circuitry (MCUs, etc.) and have overcurrent and thermal protection features.



SSOP30-P-300-0.65

## 2. Applications

- Programmable logic controller for Industrial Use.
- Driving resistant load and inductive loads.

#### 3. Features

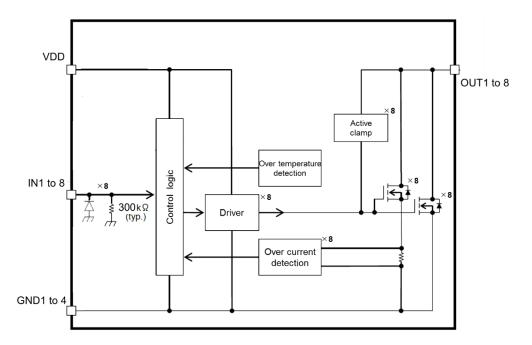
- 8-channels of N-channel MOSFET are built-in.
- This IC can drive the power load directly.
- Built-in protection against over temperature and over current.
- 8-channels access enables space-saving design.
- Low voltage operation is possible: 2.7 V
- Low on resistance:  $0.55\Omega$  (max) @ V<sub>IN</sub> = 5V, I<sub>OUT</sub> = 0.5A, T<sub>i</sub> = 25°C (per channels)
- Parallel operation is possible.
- Built-in active clamp circuit.
- SSOP30 packaging (300 mils) is embossed taping.

Note: This product has a MOS structure. Be careful of static electricity when handling it.

Start of commercial production 2022-05



### 4. Block Diagram



Note: Some of the functional blocks, circuits, constants, etc. in the block diagram are omitted and simplified.

Figure 4.1 Block Diagram



# 5. Pin Assignments

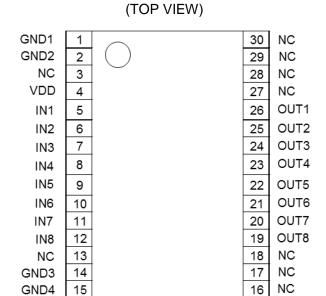


Figure 5.1 Pin Assignments



# 6. Pin Description

Table 6.1 Pin Description

Pin No.	Symbol	I/O	Pin Description
1	GND1	-	GND pin.
2	GND2	-	GND pin.
3	NC	-	No-Connect pin.
4	VDD	-	Power supply pin.
5	IN1	IN	Input pin for channel 1. Built in pull down resistor (300kΩ typ.).
6	IN2	IN	Input pin for channel 2. Built in pull down resistor (300kΩ typ.).
7	IN3	IN	Input pin for channel 3. Built in pull down resistor (300kΩ typ.).
8	IN4	IN	Input pin for channel 4. Built in pull down resistor (300kΩ typ.).
9	IN5	IN	Input pin for channel 5. Built in pull down resistor (300kΩ typ.).
10	IN6	IN	Input pin for channel 6. Built in pull down resistor (300kΩ typ.).
11	IN7	IN	Input pin for channel 7. Built in pull down resistor (300kΩ typ.).
12	IN8	IN	Input pin for channel 8. Built in pull down resistor (300kΩ typ.).
13	NC	-	No-Connect pin.
14	GND3	-	GND pin.
15	GND4	-	GND pin.
16	NC	-	No-Connect pin.
17	NC	-	No-Connect pin.
18	NC	-	No-Connect pin.
19	OUT8	OUT	Output pin of channel 8.
20	OUT7	OUT	Output pin of channel 7.
21	OUT6	OUT	Output pin of channel 6.
22	OUT5	OUT	Output pin of channel 5.
23	OUT4	OUT	Output pin of channel 4.
24	OUT3	OUT	Output pin of channel 3.
25	OUT2	OUT	Output pin of channel 2.
26	OUT1	OUT	Output pin of channel 1.
27	NC	-	No-Connect pin.
28	NC	-	No-Connect pin.
29	NC	-	No-Connect pin.
30	NC	-	No-Connect pin.



## 7. Operational Description

#### 7.1. Over temperature protection

To prevent destruction due to temperature rise, the outputs are turned off when the junction temperature of this product exceeds the overheat detection temperature (TsD). When the junction temperature falls below the hysteresis set temperature (TsD- $\Delta$ TsD), the unit recovers to normal operation.

#### 7.2. Over current protection

When the output current exceeds the overcurrent detection value (I<sub>OC</sub>) due to a load short-circuit, etc., the output is turned off for the overcurrent protection operation time (t<sub>OFF-DUTY</sub>). The output will then recover, but if the overcurrent condition persists, the output will be turned off again for the overcurrent protective operation period (t<sub>OFF-DUTY</sub>).

#### 7.3. Timing chart

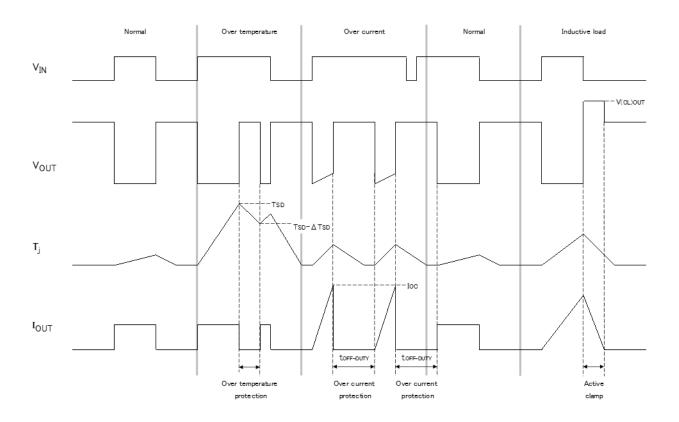


Figure 7.1 Timing chart



### 7.4. Truth table

**Table 7.1 Truth table** 

Input	Output	Operating state
L	Н	Normal
Н	L	Nomai
L	Н	Over current protection
Н	Switching	( Load short circuit )
L	Н	Over temperature protection
Н	Н	Over temperature protection



## 8. Absolute Maximum Ratings

**Table 8.1 Absolute Maximum Ratings** 

 $(T_a = 25^{\circ}C \text{ unless otherwise specified})$ 

Characteristics	Symbol	Rating	Unit
Supply voltage	$V_{DD}$	-0.3 to 6.0	V
Input voltage	$V_{IN}$	-0.3 to 6.0	V
Output withstand voltage	Vouт	50.0 <sup>1)</sup>	V
Output current	Іоит	Internally limited	А
Power dissipation (operation all channels, Ta=25°C)	$P_{D}$	1.8	W
Operating temperature	T <sub>opr</sub>	-40 to 110	°C
Junction temperature	Tj	150	°C
Storage temperature	T <sub>stg</sub>	−55 to 150	°C

Note1: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

1) Not subject to production test

#### 8.1. Thermal Resistance

Table 8.2 Thermal resistance

Characteristics	Symbol	Rating	Unit	
Thermal resistance ( junction to ambient )	R <sub>th (j–a)</sub>	70	°C/W	

Note: JEDEC Standard.

Glass epoxy board Material: FR-4(4 layer)

Board size: 76.2mmx114.3mmx1.6mm



# 9. Operating Ranges

**Table 9.1 Operating supply voltage** 

Characteristics	Symbol	Condition	Min	Тур.	Max	Unit
Operating supply voltage	V <sub>DD(opr)</sub>	$T_j = 25$ °C	2.7	-	5.5	V

## 10. Electrical Characteristics

**Table 10.1 Electrical Characteristics** 

 $(T_j = 25^{\circ}C, V_{DD} = 2.7 \text{ to } 5.5V \text{ unless otherwise specified})$ 

Charac	teristics	Symbol	Test condition	Min	Тур.	Max	Unit	
Output clamp voltage		V <sub>(CL)OUT</sub>	$I_{OUT} = 10$ mA, $V_{IN} = 0$ V	40	-	50	V	
Supply current		I <sub>DD(OFF)</sub>	V <sub>DD</sub> =5V, V <sub>IN</sub> = 0V	-	1.8	2.6	mA	
		I <sub>DD(ON)</sub>	V <sub>DD</sub> =5V, V <sub>IN</sub> = 5V, All outputs open	-	2.2	3.1	mA	
Innut voltage	"L" level	VIL	-	-	-	0.8	V	
Input voltage	"H" level	V <sub>IH</sub>	-	2.0	-	-	V	
Innut ourrent		I <sub>IL</sub>	V <sub>IN</sub> = 0V	-1.0	-	1.0		
Input current		Іін	V <sub>IN</sub> = 5V	-	17	23	μA	
On resistance		R <sub>DS</sub> (ON)	V <sub>DD</sub> = 5V, V <sub>IN</sub> = 5V, I <sub>OUT</sub> = 0.5A	-	0.40	0.55	Ω	
Output leakage current		loL	V <sub>L</sub> = 40V, V <sub>IN</sub> = 0V, Per output	-	-	10	μA	
Over current de	tection	loc	$V_{DD} = 5V$	1.0	1.5	2.5	Α	
Over current protection operation time		toff-duty	V <sub>DD</sub> = 5V	1.5	3.0	4.8	ms	
Over	Temperature	T <sub>SD</sub>	$V_{DD} = 5V$	150	175	200		
temperature detection	Hysteresis	ΔT <sub>SD</sub>	V <sub>DD</sub> = 5V	5	15	25	°C	
Switching time		ton	Refer to test circuit 1	5	10	18	110	
Switching time		toff	Velet to fest clicuit 1	3	8	15	μs	
Single pulse energy		Es	T <sub>a</sub> =25℃, I <sub>OUT</sub> =0.75A (1-channel operation)	30	150 <sup>2)</sup>	-	mJ	

Not subject to production test



# 11. Test circuit

#### 11.1. Test circuit 1

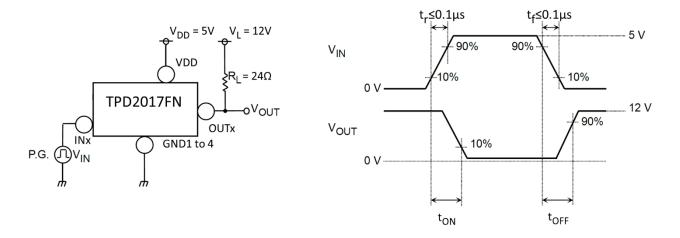
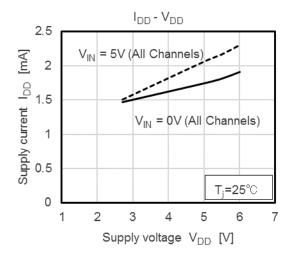


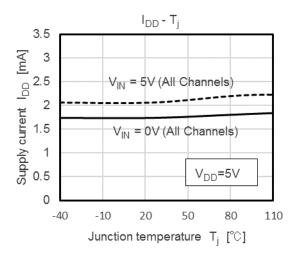
Figure 11.1 Switching time measurement circuit

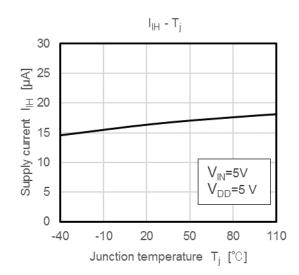


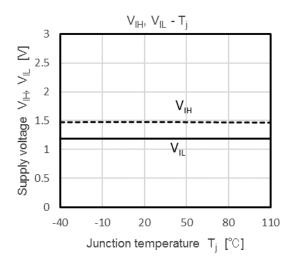
## 12. Characteristic curves

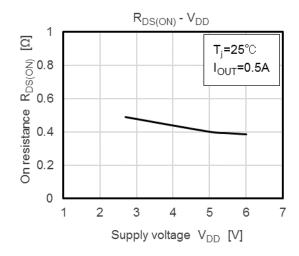
The values in the characteristic diagram are not guaranteed values unless otherwise specified, but reference values.

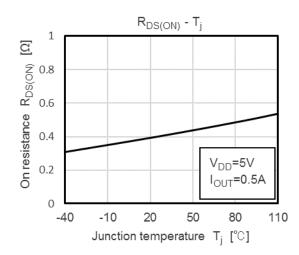




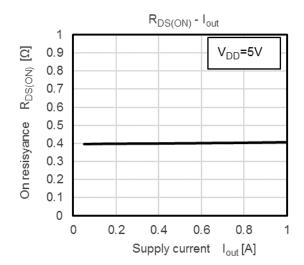


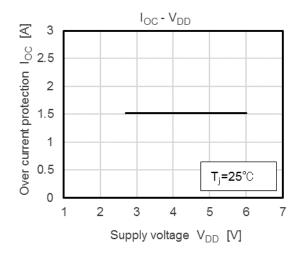


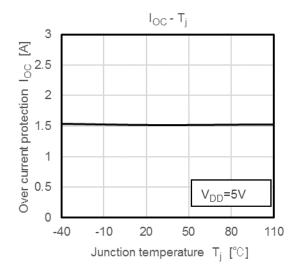


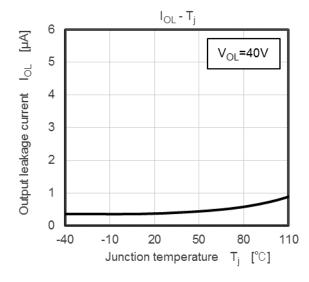


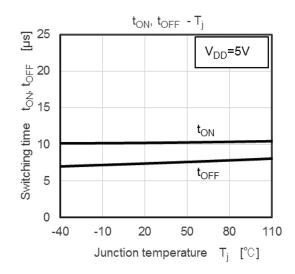


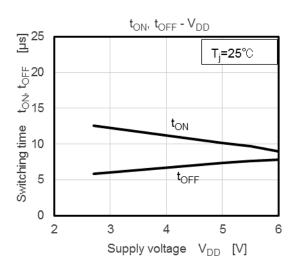




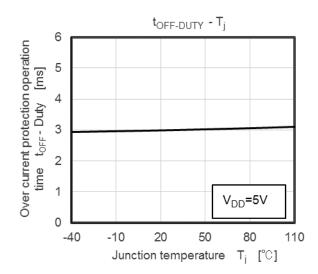


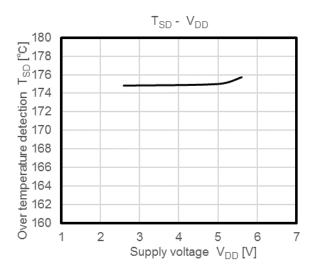


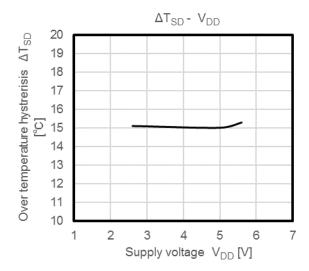






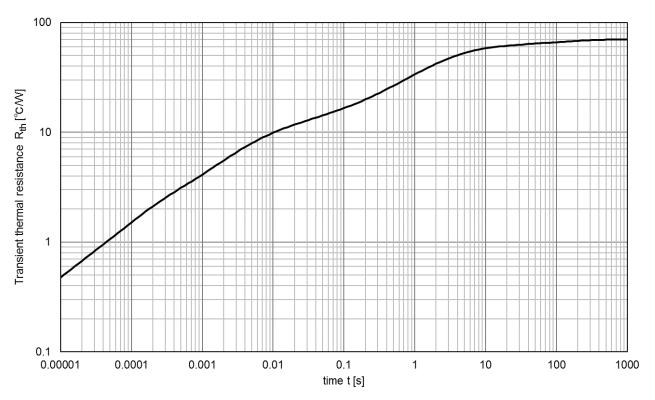








### Rth - t (1-channel operation)

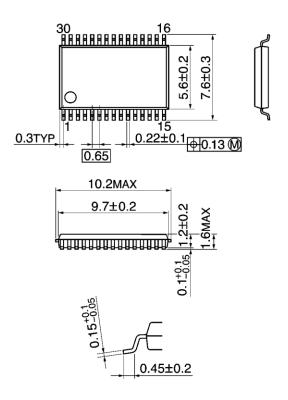




## 13. Package Information

### 13.1. Package Dimensions

Unit: mm



Weight: 0.176 g (Typ.)

Figure 13.1 Package Dimensions



#### 13.2. Marking

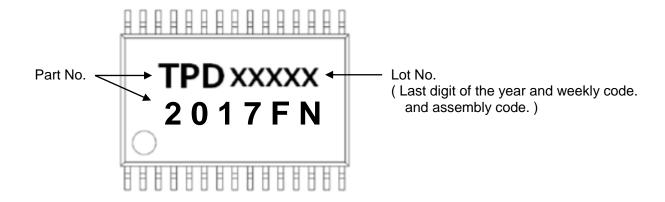


Figure 13.2 Marking

### 13.3. Land Pattern Dimensions for Reference only

SSOP30-P-300-0.65

5.35 5.35 1.45

図 13.3 Land Pattern Dimensions for Reference only



### 14. IC Usage Considerations

#### 14.1. Notes on handling of ICs

The absolute maximum ratings of a semiconductor device are a set of ratings that must not be exceeded, even for a moment.

Since the power supply reverse connection protection is not built-in, take measures with an external circuit.

Since the negative bias protection circuit of the output terminal is not built-in, when a negative bias is applied to the output terminal, be sure to connect a diode for back electromotive voltage absorption (FWD) between OUT and GND.

#### 14.2. Notes on moisture-proof packaging

After opening the moisture-proof package, mount it within 168 hours in an environment of 30°C and RH 60% or less.

Since it cannot be baked due to embossing, be sure to use it within the permissible range after opening the moisture-proof packaging.

The standard packing quantity for taping is 2000 pieces / reel.



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